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\mathscr{G}	AI	JP 6-79340		03/1994		Japan		With English abstract and full English translation						
1. D.	AJ	JP 6-266474		09/1994		Japan		With English abstract.						
1. G.	AK	JP 11-95873		04/1999				With English abstract and full English translation						
1. D.	AL	JP 2001-153574		06/2001		Japan W		With English abstract and full English translation						
	ОТ	HER DO	CUMENTS (Includ	ina	Auth	or. T	it.	le. D	ate. P	ages.	Etc.)	
19	AM	CHER DOCUMENTS (Including Author, Title, Date, Pages, Etc.) English Translation of International Search Report mailed July 15, 2003 in PCT International Application No. PCT/JP03/04678 (3 pages)												
·D.	AN	Shimizu, A., "A Flexible Heat Pipe with Carbon Fiber Arterial Work", Proceedings of the 11th International Heat Pipe Conference, The Japan Association for Heat Pipes, September 1999, pp. 149-153.												
D .	AO	"Practical Heat Pipe", Nikkan Kogyo Newspaper Co., The Japan Association for Heat Pipes, July 2001, Cover page, pp. 120-133 and 254-259.												
1.8-	AP	Miyazaki, Y., et al., "Oscillatory Flow in the Oscillating Heat Pipe", Fukui University of Technology, Fukui, Japan (7 pages)												
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xaminer nitials*	Cite No.	NON PATENT L (Include Author, Title,	ITERATURE DOCUMEN, Date, Pages, Etc.)	NTS					

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"Water Cooling Modules for Notebook PCs" by T. Nakagawa, Vol. 84 No. 11, 2002, 715-718, 51-54, in Japanese, with

DATE CONSIDERED

English translation of the gist of the publication.